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Dated: February 8, 2005

Signature: _____

(Michael R. Hull)

Docket No.: 30205/38081A
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Jae H. Kim et al.

Application No.: 10/719,135

Confirmation No.: 2226

Filed: November 21, 2003

Art Unit: 1755

For: CHEMICAL MECHANICAL POLISHING
SLURRY FOR RUTHENIUM TITANIUM
NITRIDE AND POLISHING PROCESS USING
THE SAME

Examiner: Michael A. Marcheschi

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the office action dated November 12, 2004, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.